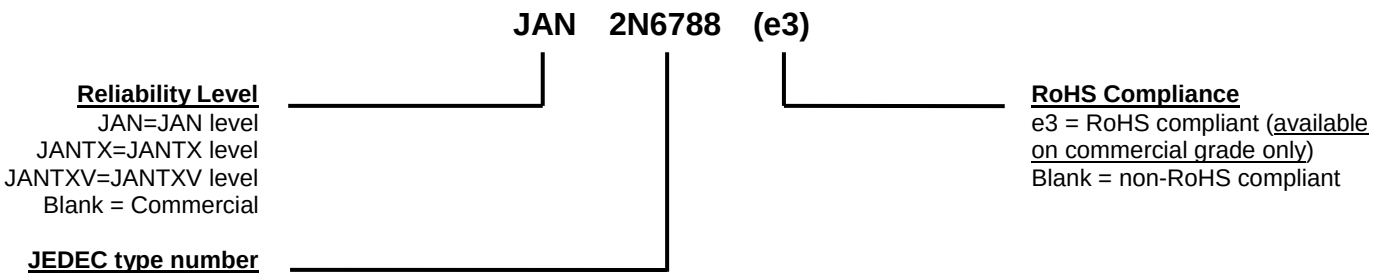
MECHANICAL and PACKAGING

- CASE: Hermetically sealed, kovar base, nickel cap.
- TERMINALS: Tin/lead solder dip nickel plate or RoHS compliant pure tin plate (commercial grade only).
- MARKING: Part number, date code, manufacturer's ID.
- WEIGHT: Approximately 1.064 grams.
- See Package Dimensions on last page.

PART NOMENCLATURE



SYMBOLS & DEFINITIONS

Symbol	Definition
I_D	Drain current.
I_F	Forward current.
T_C	Case temperature.
V_{DD}	Drain supply voltage.
V_{DS}	Drain to source voltage.
V_{GS}	Gate to source voltage.

ELECTRICAL CHARACTERISTICS @ T_A = +25 °C, unless otherwise noted

Parameters / Test Conditions		Symbol	Min.	Max.	Unit
OFF CHARACTERTICS					
Drain-Source Breakdown Voltage V_{GS} = 0 V, I_D = 1 mA	2N6788 2N6790	$V_{(BR)DSS}$	100 200		V
Gate-Source Voltage (Threshold) $V_{DS} \geq V_{GS}$, I_D = 0.25 mA $V_{DS} \geq V_{GS}$, I_D = 0.25 mA, T_j = +125 °C $V_{DS} \geq V_{GS}$, I_D = 0.25 mA, T_j = -55 °C		$V_{GS(th)1}$ $V_{GS(th)2}$ $V_{GS(th)3}$	2.0 1.0	4.0 5.0	V
Gate Current V_{GS} = ±20 V, V_{DS} = 0 V V_{GS} = ±20 V, V_{DS} = 0 V, T_j = +125 °C		I_{GSS1} I_{GSS2}		±100 ±200	nA

Parameters / Test Conditions		Symbol	Min.	Max.	Unit
ON CHARACTERISTICS					
Drain Current V_{GS} = 0V, V_{DS} = 80 V V_{GS} = 0V, V_{DS} = 160 V	 2N6788 2N6790	I_{DSS1}		25	µA
Drain Current V_{GS} = 0V, V_{DS} = 80 V, T_j = +125 °C V_{GS} = 0V, V_{DS} = 160 V, T_j = +125 °C	 2N6788 2N6790	I_{DSS2}		0.25	mA
Static Drain-Source On-State Resistance V_{GS} = 10 V, I_D = 3.5 A pulsed V_{GS} = 10 V, I_D = 2.25 A pulsed	 2N6788 2N6790	$r_{DS(on)1}$		0.30 0.80	Ω
Static Drain-Source On-State Resistance V_{GS} = 10 V, I_D = 6.0 A pulsed V_{GS} = 10 V, I_D = 3.5 A pulsed	 2N6788 2N6790	$r_{DS(on)2}$		0.35 0.85	Ω
Static Drain-Source On-State Resistance T_j = +125 °C: V_{GS} = 10 V, I_D = 3.5 A pulsed V_{GS} = 10 V, I_D = 2.25 A pulsed	 2N6788 2N6790	$r_{DS(on)3}$		0.54 1.50	Ω
Diode Forward Voltage V_{GS} = 0 V, I_D = 6.0 A pulsed V_{GS} = 0 V, I_D = 3.5 A pulsed	 2N6788 2N6790	V_{SD}		1.8 1.5	V

ELECTRICAL CHARACTERISTICS @ T_A = +25 °C, unless otherwise noted (continued)

DYNAMIC CHARACTERISTICS

Parameters / Test Conditions		Symbol	Min.	Max.	Unit
Gate Charge:					
On-State Gate Charge V_{GS} = 10 V, I_D = 6.0 A, V_{DS} = 50 V V_{GS} = 10 V, I_D = 3.5 A, V_{DS} = 100 V	2N6788 2N6790	$Q_{g(on)}$		18.0 14.3	nC
Gate to Source Charge V_{GS} = 10 V, I_D = 6.0 A, V_{DS} = 50 V V_{GS} = 10 V, I_D = 3.5 A, V_{DS} = 100 V	2N6788 2N6790	Q_{gs}		4.0 3.0	nC
Gate to Drain Charge V_{GS} = 10 V, I_D = 6.0 A, V_{DS} = 50 V V_{GS} = 10 V, I_D = 3.5 A, V_{DS} = 100 V	2N6788 2N6790	Q_{gd}		9.0 9.0	nC

SWITCHING CHARACTERISTICS

Parameters / Test Conditions		Symbol	Min.	Max.	Unit
Turn-on delay time I_D = 6.0 A, V_{GS} = 10 V, R_G = 7.5 Ω, V_{DD} = 35 V I_D = 3.5 A, V_{GS} = 10 V, R_G = 7.5 Ω, V_{DD} = 74 V	2N6788 2N6790	$t_{d(on)}$		40	ns
Rinse time I_D = 6.0 A, V_{GS} = 10 V, R_G = 7.5 Ω, V_{DD} = 35 V I_D = 3.5 A, V_{GS} = 10 V, R_G = 7.5 Ω, V_{DD} = 74 V	2N6788 2N6790	t_r		70 50	ns
Turn-off delay time I_D = 6.0 A, V_{GS} = 10 V, R_G = 7.5 Ω, V_{DD} = 35 V I_D = 3.5 A, V_{GS} = 10 V, R_G = 7.5 Ω, V_{DD} = 74 V	2N6788 2N6790	$t_{d(off)}$		40 50	ns
Fall time I_D = 6.0 A, V_{GS} = 10 V, R_G = 7.5 Ω, V_{DD} = 35 V I_D = 3.5 A, V_{GS} = 10 V, R_G = 7.5 Ω, V_{DD} = 74 V	2N6788 2N6790	t_f		70 50	ns
Diode Reverse Recovery Time di/dt = 100 A/µs, V_{DD} ≤ 50 V, I_F = 6.0 A di/dt = 100 A/µs, V_{DD} ≤ 50 V, I_F = 3.5 A	2N6788 2N6790	t_{rr}		240 400	ns

GRAPHS

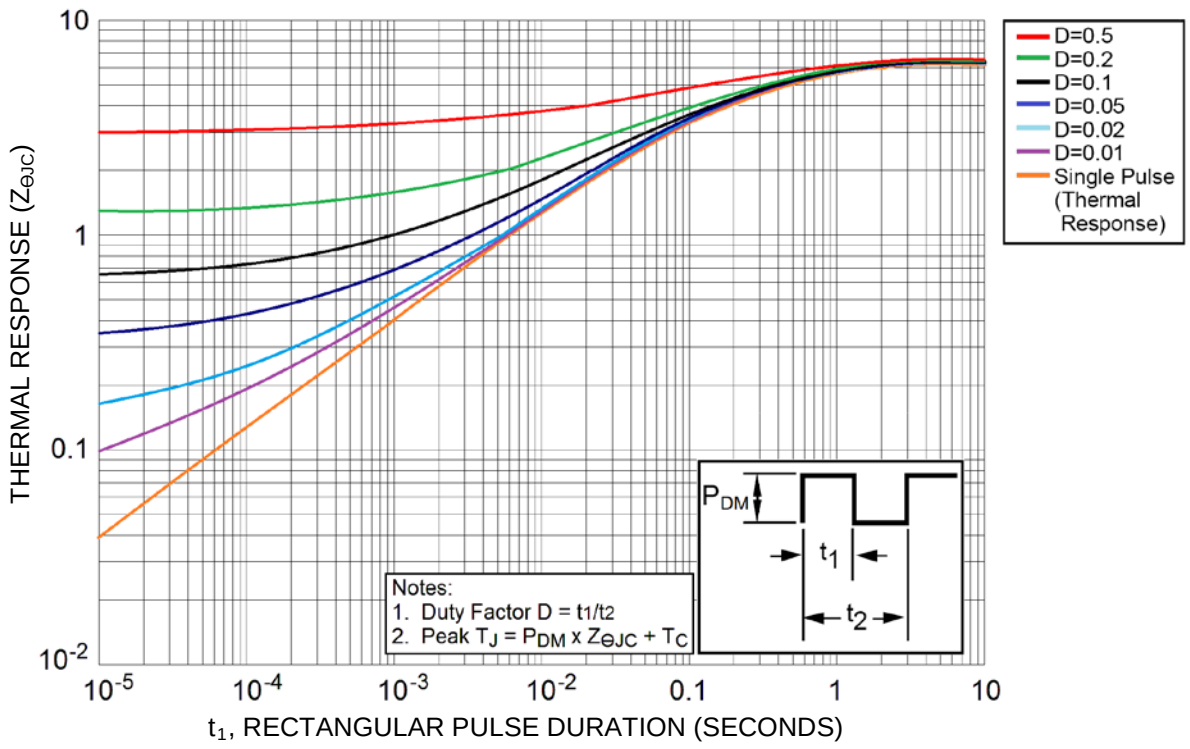


Figure 1
Thermal Impedance Curves

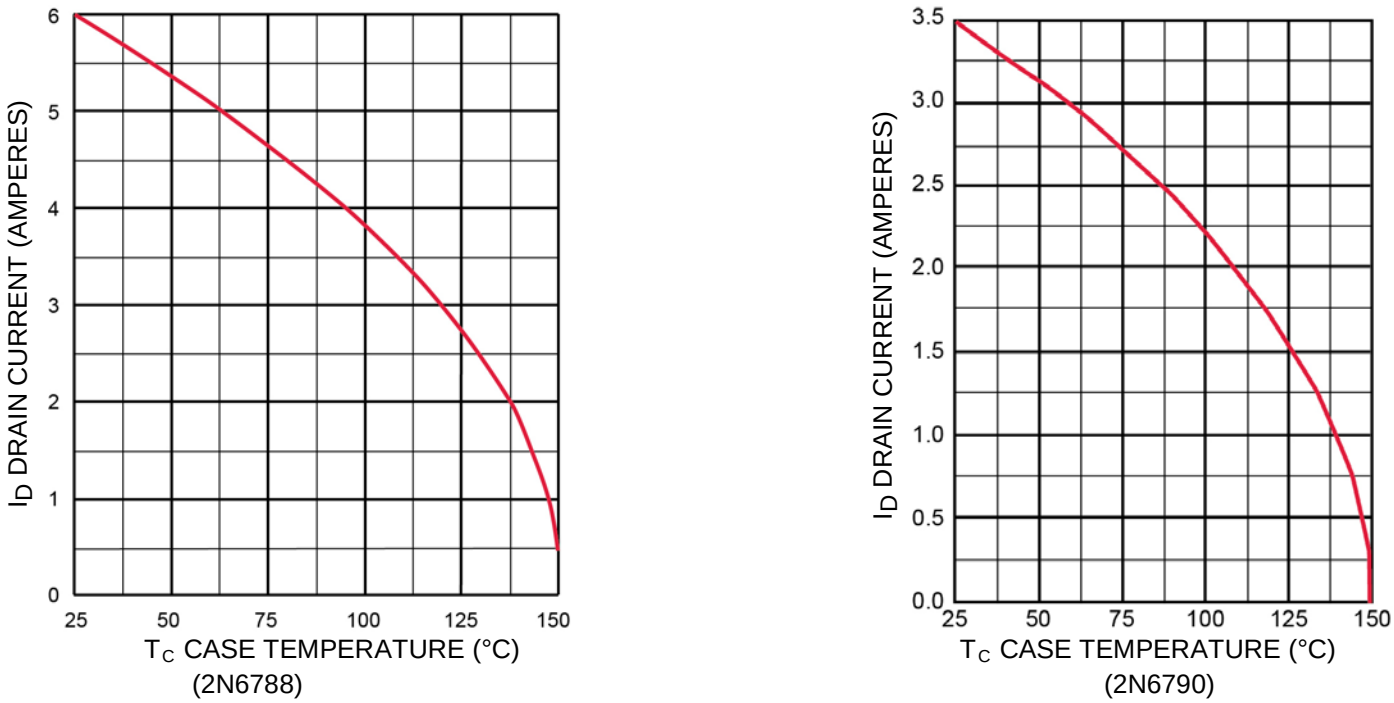
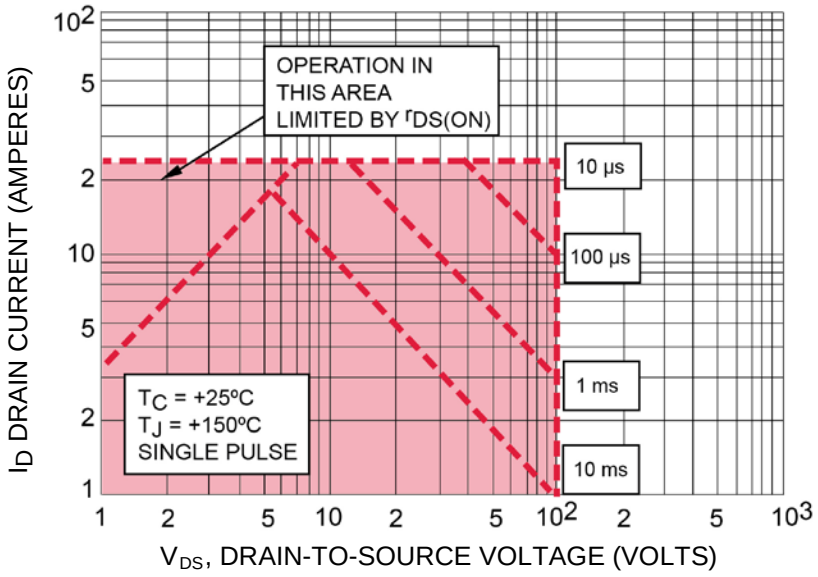
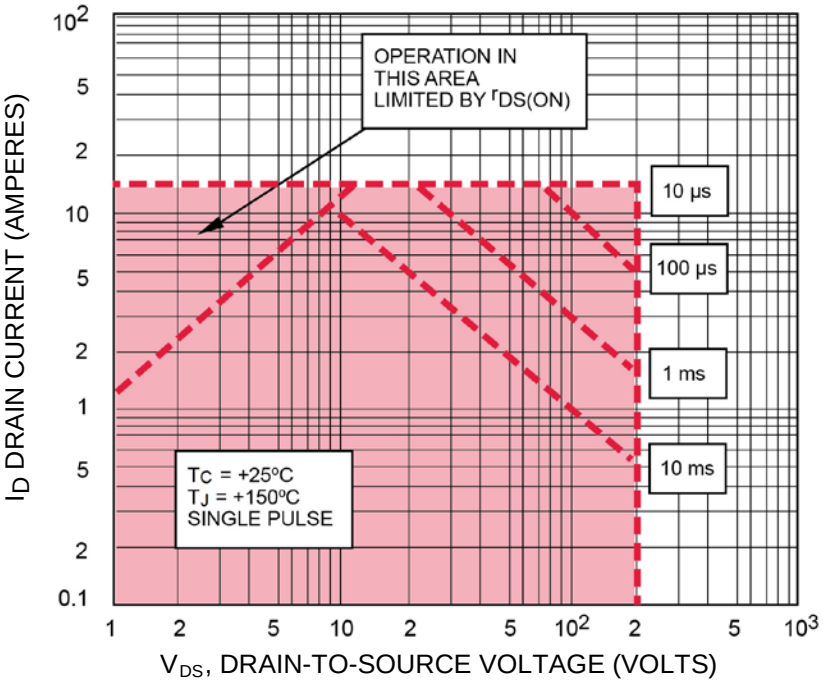


Figure 2
Maximum Drain Current vs. Case Temperature Graph

GRAPHS (continued)

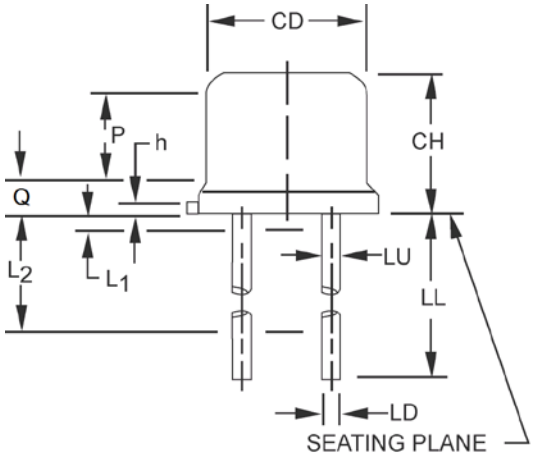


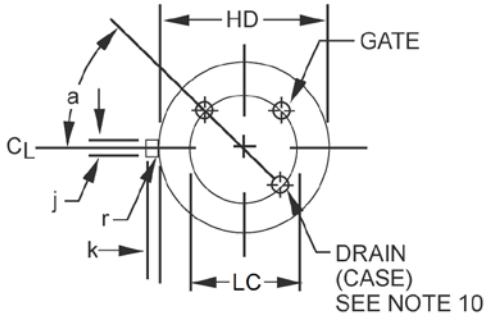
Maximum Safe Operating Area (2N6788)

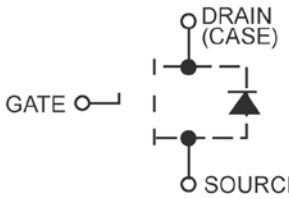


Maximum Safe Operating Area (2N6790)

PACKAGE DIMENSIONS







SCHEMATIC CIRCUIT

Ltr	Dimensions				Notes
	Inch		Millimeters		
	Min	Max	Min	Max	
CD	.305	.335	7.75	8.51	
CH	.160	.180	4.07	4.57	
HD	.335	.370	8.51	9.40	
h	.009	.041	0.23	1.04	
J	.028	.034	0.71	0.86	3
k	.029	.045	0.74	1.14	3, 4
LD	.016	.021	0.41	0.53	7, 8
LL	.500	.750	12.7	19.05	7, 8, 12
LS	.200 TP		5.08 TP		6
LU	.016	.019	0.41	0.48	7, 8
L1		.050		1.27	7, 8
L2	.250		6.35		7, 8
P	.100		2.54		
Q		.050		1.27	5
r		.010		0.25	10
α	45° TP		45° TP		6

NOTES:

1. Dimensions are in inches.
2. Millimeters are given for general information only.
3. Beyond r (radius) maximum, TL shall be held for a minimum length of .011 inch (0.28 mm).
4. Dimension TL measured from maximum HD.
5. Body contour optional within zone defined by HD, CD, and Q.
6. Leads at gauge plane .054 +.001 -.000 inch (1.37 +0.03 -0.00 mm) below seating plane shall be within .007 inch (0.18 mm) radius of true position (TP) at maximum material condition (MMC) relative to tab at MMC.
7. Dimension LU applies between L1 and L2. Dimension LD applies between L2 and LL minimum. Diameter is uncontrolled in L1 and beyond LL minimum.
8. All three leads.
9. The collector shall be internally connected to the case.
10. Dimension r (radius) applies to both inside corners of tab.
11. In accordance with ASME Y14.5M, diameters are equivalent to Φx symbology.
12. Lead 1 = source, lead 2 = gate, lead 3 = drain.